

# **Peer-Review Statements**

Badrul Hisham Ahmad<sup>(⊠)</sup>

Faculty of Electronics and Computer Engineering, University Teknikal Malaysia Melaka (UTeM), Malacca, Malaysia badrulhisham@utem.edu.my

All of the articles in this proceedings volume have been presented at the DAI 2023 during November 24–26 in Shanghai. These articles have been peer reviewed by the members of the Academic Committee Members and approved by the Editor-in-Chief, who affirms that this document is a truthful description of the conference's review process.

### **1 REVIEW PROCEDURE**

The reviews were double-blind. Each submission was examined by at least 2 reviewers independently.

The submissions were first screened for generic quality and suitableness. After the initial screening, they were sent for peer review by matching each paper's topic with the reviewers' expertise, taking into account any research interests. A paper could only be considered for acceptance if it had received favourable recommendations from the two reviewers.

Authors of a rejected submission were given the opportunity to revise and resubmit after addressing the reviewers' comments. The acceptance or rejection of a revised manuscript was final.

An overall evaluation or detailed reviewing result (if any) will be given. In the end of the review, the final decision of Accept/Revision/Reject will be selected. When it is marked by Revision, we will have a double check of the revised papers before acceptation.

# 2 QUALITY CRITERIA

Reviewers were instructed to assess the quality of submissions solely based on the academic merit of their content along the following dimensions

- 1. Pertinence of the article's content to the scope and themes of the conference;
- 2. Clear demonstration of originality, novelty, and timeliness of the research;
- 3. Soundness of the methods, analyses, and results;
- 4. Adherence to the ethical standards and codes of conduct relevant to the research field;
- 5. Clarity, cohesion, and accuracy in language and other modes of expression, including figures and tables;

B. H. Ahmad-Editors-in-Chief of the DAI 2023.

<sup>©</sup> The Author(s) 2024

B. H. Ahmad (ed.), Proceedings of the 2023 International Conference on Data Science, Advanced Algorithm and Intelligent Computing (DAI 2023), Advances in Intelligent Systems Research 180, https://doi.org/10.2991/978-94-6463-370-2\_1

#### 2 B. H. Ahmad

6. Inclusion of Author information, Abstract, Keywords, Introduction, Methods and Materials, Conclusions, References, Acknowledgments (If applicable).

In addition, all of the articles have been double checked by authors themself and technical committee for textual overlap in an effort to detect possible signs of plagiarism by the publisher.

### **3 KEY METRICS**

Total submissions	133
Number of articles sent for peer	120
review	
Number of accepted articles	70
Acceptance rate	52.6%
Number of reviewers	12

# **4 COMPETING INTERESTS**

Neither the Editor-in-Chief nor any member of the Scientific Committee declares any competing interest.

**Open Access** This chapter is licensed under the terms of the Creative Commons Attribution-NonCommercial 4.0 International License (http://creativecommons.org/licenses/by-nc/4.0/), which permits any noncommercial use, sharing, adaptation, distribution and reproduction in any medium or format, as long as you give appropriate credit to the original author(s) and the source, provide a link to the Creative Commons license and indicate if changes were made.

The images or other third party material in this chapter are included in the chapter's Creative Commons license, unless indicated otherwise in a credit line to the material. If material is not included in the chapter's Creative Commons license and your intended use is not permitted by statutory regulation or exceeds the permitted use, you will need to obtain permission directly from the copyright holder.

(00)	•	\$
	BY	NC